

AM035N4-00

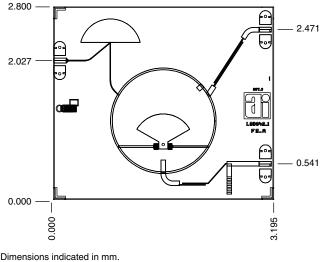
Features

- Low Conversion Loss, 6.0 dB
- Low LO Power Requirement, 9 dBm
- High LO to RF Isolation, 28 dB
- No DC Bias Required

Description

Alpha's ring hybrid GaAs Schottky diode mixer has a typical conversion loss of 6.0 dB at an LO power level as low as 9 dBm over the band 32–37 GHz. The chip uses Alpha's proven Schottky diode technology, and is based upon MBE layers for the highest uniformity and repeatability. The diodes employ surface passivation to ensure a rugged, reliable part with through-substrate via holes and gold-based backside metallization to facilitate an epoxy die attach process. All chips are screened for DC diode parameters and lot samples are RF measured to guarantee performance.

Chip Outline



Dimensions indicated in mm. All pads are ≥ 0.07 mm wide. Chip thickness = 0.1 mm.

Absolute Maximum Ratings

Characteristic	Value		
Operating Temperature	-55°C to +125°C		
Storage Temperature	-65°C to +150°C		
Total Input Power (RF + LO)	20 dBm		

Electrical Specifications at 25°C

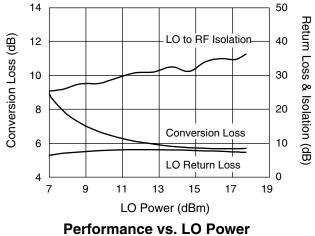
Parameter	Symbol	Min.	Typ. ²	Max.	Unit
RF and LO Frequency Range	F _{RF} , F _{LO}		32–37		GHz
IF Frequency Range	F _{IF}		0–3		GHz
LO Power Level	P _{LO}		9–19		dBm
Conversion Loss ¹	L _C		6		dB
RF and LO Return Loss ¹	RL _{RF} , RL _{LO}		9		dB
LO to RF Isolation ¹	ISO _{LO-RF}		28		dB
LO to IF Isolation ¹	ISO _{LO-IF}		35		dB
RF Input 1 dB Compression Point ¹	P _{1 dB}		10		dBm
Individual Diode Series Resistance	R _S			4.0	Ω

1. Not measured on a 100% basis.

2. Typical represents the median parameter value across the specified

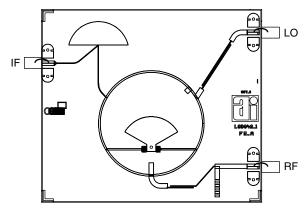
frequency range for the median chip.

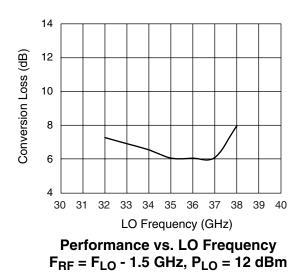




 F_{RF} = 34.5 GHz, F_{LO} = 35 GHz, P_{RF} = -10 dBm

Wire Bonding Configurations





Circuit Schematic

